

DOCKET NO.: T0529.70050US00

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Jason J. Payne et al.

Serial No.:

10/603,048

Confirmation No.:

1882

Filed:

June 24, 2003

For:

PRINTED CIRCUIT BOARD FOR HIGH SPEED, HIGH

DENSITY ELECTRICAL CONNECTOR WITH IMPROVED CROSS-TALK MINIMIZATION, ATTENUATION AND IMPEDANCE MISMATCH

**CHARACTERISTICS** 

Examiner:

Nguyen, Hoa Cao

Art Unit:

2841

## **CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)**

The undersigned hereby certifies that this document is being placed in the United States mail with first-class postage attached, addressed to MAIL STOP AMENDMENT, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the //// day of October, 2005

Signature

## MAIL STOP AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## **AMENDMENT**

Sir:

In response to the Office Action mailed July 14, 2005, please amend the above-identified application as follows:

Amendments to the Specification begin on page 2 of this amendment.

Amendments to the Drawings begin on page 3 of this amendment.

Amendments to the Claims are reflected in the listing of claims that begins on page 4 of this amendment.

Remarks begin on page 9 of this amendment.